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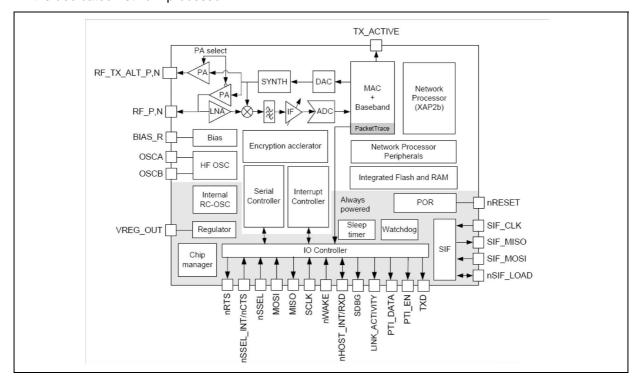


ZigBee® 802.15.4 network processor

Features

- Integrated 2.4GHz, IEEE 802.15.4-compliant transceiver:
 - Robust RX filtering allows co-existence with IEEE 802.11g and Bluetooth devices
 - 99 dBm RX sensitivity (1% PER, 20-byte packet)
 - +2.5 dBm nominal output power
 - Increased radio performance mode (Boost mode) gives –100 dBm sensitivity and +4.5 dBm transmit power
 - Integrated VCO and loop filter
 - Secondary TX-only RF port for applications requiring external PA.
- Integrated IEEE 802.15.4 PHY and MAC
- Dedicated peripherals and integrated memory
- Ember ZigBee®-compliant stack running on the dedicated network processor

- Controlled by the Host using the EmberZNetTM Serial Protocol (EZSP)
 - Standard SPI or UART interfaces allow for connection to a variety of Host microcontrollers
- Non-intrusive debug interface (SIF)
- Integrated hardware and software support for InSight™ Development Environment
- Provides integrated RC oscillator for low power operation
- Three sleep modes:
 - Processor idle (automatic)
 - Deep sleep—1.0µA
 - Power down—1.0μA
- Watchdog timer and power-on-reset circuitry
- Integrated AES encryption accelerator
- Integrated 1.8V voltage regulator



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1 Abbreviations and acronyms

Table 1. Abbreviations and acronyms

Acronym/abbreviation	Meaning
ACR	Adjacent Channel Rejection
AES	Advanced Encryption Standard
CBC-MAC	Cipher Block Chaining—Message Authentication Code
CCA	Clear Channel Assessment
CCM	Counter with CBC-MAC Mode for AES encryption
CCM*	Improved Counter with CBC-MAC Mode for AES encryption
CSMA	Carrier Sense Multiple Access
CTR	Counter Mode
EEPROM	Electrically Erasable Programmable Read Only Memory
ESD	Electro Static Discharge
ESR	Equivalent Series Resistance
FFD	Full Function Device (ZigBee)
FIA	Flash Information Area
GPIO	General Purpose I/O (pins)
HF	High Frequency (24 MHz)
I ² C	Inter-Integrated Circuit bus
IDE	Integrated Development Environment
IF	Intermediate Frequency
IP3	Third order Intermodulation Product
ISR	Interrupt Service Routine
kB	Kilobyte
kbps	kilobits/second
LF	Low Frequency
LNA	Low Noise Amplifier
LQI	Link Quality Indicator
MAC	Medium Access Control
MSL	Moisture Sensitivity Level
Msps	Mega samples per second
O-QPSK	Offset-Quadrature Phase Shift Keying
PA	Power Amplifier
PER	Packet Error Rate
PHY	Physical Layer
PLL	Phase-Locked Loop
POR	Power-On-Reset
PSD	Power Spectral Density
PSRR	Power Supply Rejection Ratio
PTI	Packet Trace Interface

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Table 1. Abbreviations and acronyms (continued)

Acronym/abbreviation	Meaning
PWM	Pulse Width Modulation
RoHS	Restriction of Hazardous Substances
RSSI	Receive Signal Strength Indicator
SFD	Start Frame Delimiter
SIF	Serial Interface
SPI	Serial Peripheral Interface
UART	Universal Asynchronous Receiver/Transmitter
VCO	Voltage Controlled Oscillator
VDD	Voltage Supply

2 References

- ZigBee Specification (www.zigbee.org; ZigBee document 053474)
- ZigBee-PRO Stack Profile (www.zigbee.org; ZigBee document 074855)
- ZigBee Stack Profile (www.zigbee.org; ZigBee document 064321)
- Bluetooth Core Specification v2.1 (www.bluetooth.com/Bluetooth/Technology/Building/Specifications/Default.htm)
- IEEE 802.15.4-2003 (standards.ieee.org/getieee802/download/802.15.4-2003.pdf)
- IEEE 802.11g (standards.ieee.org/getieee802/download/802.11g-2003.pdf)
- Ember EM260 Reference Design (ember.com/products_documentation.html)

SN260 General description

3 General description

The SN260 integrates a 2.4GHz, IEEE 802.15.4-compliant transceiver with a 16-bit network processor (XAP2b core) to run EmberZNet™, the Ember ZigBee-compliant network stack. The SN260 exposes access to the EmberZNet API across a standard SPI module or a UART module, allowing application development on a Host platform. This means that the SN260 can be viewed as a ZigBee peripheral connected over a serial interface. The XAP2b microprocessor is a power-optimized core integrated in the SN260. It contains integrated Flash and RAM memory along with an optimized peripheral set to enhance the operation of the network stack.

The transceiver utilizes an efficient architecture that exceeds the dynamic range requirements imposed by the IEEE 802.15.4-2003 standard by over 15dB. The integrated receive channel filtering allows for co-existence with other communication standards in the 2.4GHz spectrum such as IEEE 802.11g and Bluetooth. The integrated regulator, VCO, loop filter, and power amplifier keep the external component count low. An optional high-performance radio mode (boost mode) is software selectable to boost dynamic range by a further 3dB.

The SN260 contains embedded Flash and integrated RAM for program and data storage. By employing an effective wear-leveling algorithm, the stack optimizes the lifetime of the embedded Flash, and affords the application the ability to configure stack and application tokens within the SN260.

To maintain the strict timing requirements imposed by ZigBee and the IEEE 802.15.4-2003 standard, the SN260 integrates a number of MAC functions into the hardware. The MAC hardware handles automatic ACK transmission and reception, automatic backoff delay, and clear channel assessment for transmission, as well as automatic filtering of received packets. In addition, the SN260 allows for true MAC level debugging by integrating the Packet Trace Interface.

An integrated voltage regulator, power-on-reset circuitry, sleep timer, and low-power sleep modes are available. The deep sleep and power down modes draw less than 1 μ A, allowing products to achieve long battery life.

Finally, the SN260 utilizes the non-intrusive SIF module for powerful software debugging and programming of the network processor.

Target applications for the SN260 include:

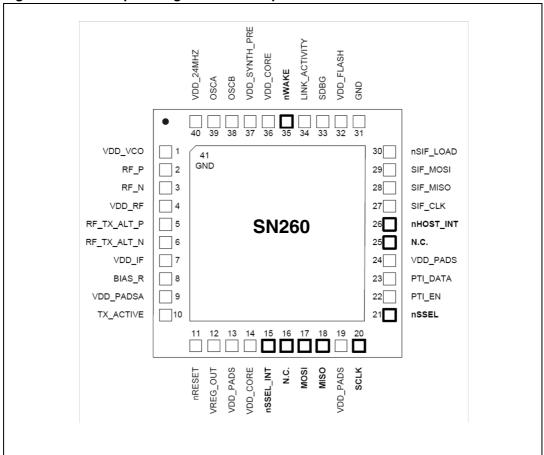
- Building automation and control
- Home automation and control
- Home entertainment control
- Asset tracking

The SN260 can only be purchased with the EmberZNet stack. This technical datasheet describes the SN260 features available to customers using it with the EmberZNet stack.

Pin assignment SN260

4 Pin assignment





SN260 Pin assignment

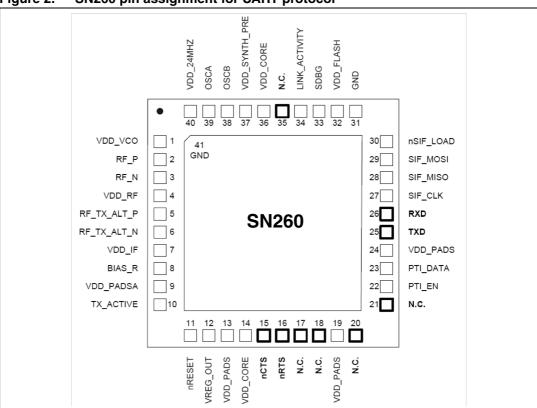


Figure 2. SN260 pin assignment for UART protocol

Table 2. Pin descriptions

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Pin #	Signal	Direction	Description
1	VDD_VCO	Power	1.8V VCO supply
2	RF_P	I/O	Differential (with RF_N) receiver input/transmitter output
3	RF_N	I/O	Differential (with RF_P) receiver input/transmitter output
4	VDD_RF	Power	1.8V RF supply (LNA and PA)
5	RF_TX_ALT_P	0	Differential (with RF_TX_ALT_N) transmitter output (optional)
6	RF_TX_ALT_N	0	Differential (with RF_TX_ALT_P) transmitter output (optional)
7	VDD_IF	Power	1.8V IF supply (mixers and filters)
8	BIAS_R	I	Bias setting resistor
9	VDD_PADSA	Power	Analog pad supply (1.8V)
10	TX_ACTIVE	0	Logic-level control for external RX/TX switch The SN260 baseband controls TX_ACTIVE and drives it high (1.8V) when in TX mode. (Refer to <i>Table 15</i> and section TX_ACTIVE signal.)
11	nRESET	I	Active low chip reset (internal pull-up)
12	VREG_OUT	Power	Regulator output (1.8V)
13	VDD_PADS	Power	Pads supply (2.1 – 3.6V)
14	VDD_CORE	Power	1.8V digital core supply

Pin assignment SN260

Table 2. Pin descriptions (continued)

Pin #	Signal	Direction	Description		
	nSSEL_INT	I	SPI Slave Select Interrupt (from Host to SN260) This signal must be connected to nSSEL (Pin 21)		
15			UART Clear To Send (enables SN260 transmission)		
	nCTS	I	When using the UART interface, this signal should be left		
			unconnected if not used.		
	N.C.	I	When using the SPI interface, this signal is left not connected.		
16		_	UART Request To Send (enables Host transmission)		
	nRTS	0	When using the UART interface, this signal should be left unconnected if not used.		
17	MOSI	I	SPI Data, Master Out / Slave In (from Host to SN260)		
17	N.C.	I	When using the UART interface, this signal is left not connected.		
18	MISO	0	SPI Data, Master In / Slave Out (from SN260 to Host)		
10	N.C.	I	When using the UART interface, this signal is left not connected.		
19	VDD_PADS	Power	Pads supply (2.1 – 3.6V)		
20	SCLK	I	SPI Clock (from Host to SN260)		
20	N.C.	I	When using the UART interface, this signal is left not connected.		
21	nSSEL	I SPI Slave Select (from Host to SN260)			
21	N.C.	I	When using the UART interface, this signal is left not connected.		
22	PTI_EN	0	Frame signal of Packet Trace Interface (PTI)		
23	PTI_DATA	0	Data signal of Packet Trace Interface (PTI)		
24	VDD_PADS	Power	Pads supply (2.1 – 3.6V)		
25	N.C.	I	When using the SPI interface, this signal is left not connected.		
25	TXD	0	UART Transmitted Data (from SN260 to Host)		
26	nHOST_INT	0	Host Interrupt signal (from SN260 to Host)		
20	RXD	I	UART Received Data (from Host to SN260)		
27	SIF_CLK	I	Programming and Debug Interface, Clock (internal pull down)		
28	SIF_MISO	0	Programming and Debug Interface, Master In / Slave Out		
29	SIF_MOSI	I	Programming and Debug Interface, Master Out / Slave In (external pull-down re-quired to guarantee state in Deep Sleep Mode)		
30	nSIF_LOAD	I/O	Programming and Debug Interface, load strobe (open collector with internal pull up)		
31	GND	Power	Ground supply		
32	VDD_FLASH	Power	1.8V Flash memory supply		
33	SDBG	0	Spare Debug signal		
34	LINK_ACTIVITY	0	Link and Activity signal		
25	nWAKE	I	Wake Interrupt signal (from Host to SN260)		
35	N.C.	I	When using the UART interface, this signal is left not connected.		
36	VDD_CORE	Power	1.8V digital core supply		
37	VDD_SYNTH_PRE	Power	1.8V synthesizer and pre-scalar supply		

SN260 Pin assignment

Table 2. Pin descriptions (continued)

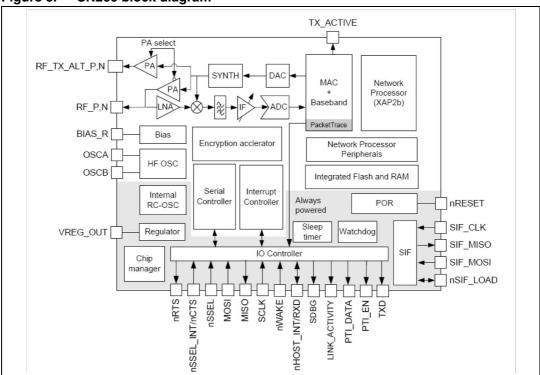
Pin #	Signal	Direction	Description			
38	OSCB	I/O	24MHz crystal oscillator or left open for when using an external clock input on OSCA			
39	OSCA	I/O	24MHz crystal oscillator or external clock input			
40	VDD_24MHZ	Power	1.8V high-frequency oscillator supply			
41	GND	Ground	Ground supply pad in the bottom center of the package forms Pin 41 (see the <i>SN260 Reference Design</i> for PCB considerations)			

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5 Top-level functional description

Figure 3 shows a detailed block diagram of the SN260.

Figure 3. SN260 block diagram



The radio receiver is a low-IF, super-heterodyne receiver. It utilizes differential signal paths to minimize noise interference, and its architecture has been chosen to optimize coexistence with other devices within the 2.4GHz band (namely, IEEE 802.11g and Bluetooth). After amplification and mixing, the signal is filtered and combined prior to being sampled by an ADC.

The digital receiver implements a coherent demodulator to generate a chip stream for the hardware-based MAC. In addition, the digital receiver contains the analog radio calibration routines and control of the gain within the receiver path.

The radio transmitter utilizes an efficient architecture in which the data stream directly modulates the VCO. An integrated PA boosts the output power. The calibration of the TX path as well as the output power is controlled by digital logic. If the SN260 is to be used with an external PA, the TX_ACTIVE signal should be used to control the timing of the external switching logic.

The integrated 4.8 GHz VCO and loop filter minimize off-chip circuitry. Only a 24MHz crystal with its loading capacitors is required to properly establish the PLL reference signal.

The MAC interfaces the data memory to the RX and TX baseband modules. The MAC provides hardware-based IEEE 802.15.4 packet-level filtering. It supplies an accurate symbol time base that minimizes the synchronization effort of the software stack and meets the protocol timing requirements. In addition, it provides timer and synchronization assistance for the IEEE 802.15.4 CSMA-CA algorithm.

The SN260 integrates hardware support for a Packet Trace module, which allows robust packet-based debug. This element is a critical component of InSight Desktop, the Ember software IDE, providing advanced network debug capability when coupled with the InSight Adapter.

The SN260 integrates a 16-bit XAP2b microprocessor developed by Cambridge Consultants Ltd. This power-efficient, industry-proven core provides the appropriate level of processing power to meet the needs of the Ember ZigBee-compliant stack, EmberZNet. In addition, the SIF module provides a non-intrusive programming and debug interface allowing for real-time application debugging.

The SN260 exposes the Ember Serial API over either a SPI or UART interface, which allows application development to occur on a Host platform of choice. The SPI interface uses the four standard SPI signals plus two additional signals, nHOST_INT and nWAKE, which provide an easy-to-use handshake mechanism between the Host and the SN260. The UART interface uses the two standard UART signals and also supports either standard RTS/CTS or XON/XOFF flow control.

The integrated voltage regulator generates a regulated 1.8V reference voltage from an unregulated supply voltage. This voltage is decoupled and routed externally to supply the 1.8V to the core logic. In addition, an integrated POR module allows for the proper cold start of the SN260.

The SN260 contains one high-frequency (24 MHz) crystal oscillator and, for low-power operation, a second low-frequency internal 10 kHz oscillator.

The SN260 contains two power domains. The always-powered High Voltage Supply is used for powering the GPIO pads and critical chip functions. The rest of the chip is powered by a regulated Low Voltage Supply which can be disabled during deep sleep to reduce the power consumption.

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6 Functional description

The SN260 connects to the Host platform through either a standard SPI interface or a standard UART interface. The EmberZNet Serial Protocol (EZSP) has been defined to allow an application to be written on a host platform of choice. Therefore, the SN260 comes with a license to EmberZNet, the Ember ZigBee-compliant software stack. The following brief description of the hardware modules provides the necessary background on the operation of the SN260. For more information, contact your local ST sales representative.

6.1 Receive (RX) path

The SN260 RX path spans the analog and digital domains. The RX architecture is based on a low-IF, super-heterodyne receiver. It utilizes differential signal paths to minimize noise interference. The input RF signal is mixed down to the IF frequency of 4MHz by I and Q mixers. The output of the mixers is filtered and combined prior to being sampled by a 12Msps ADC. The RX filtering within the RX path has been designed to optimize the coexistence of the SN260 with other 2.4GHz transceivers, such as the IEEE 802.11g and Bluetooth.

6.1.1 RX baseband

The SN260 RX baseband (within the digital domain) implements a coherent demodulator for optimal performance. The baseband demodulates the O-QPSK signal at the chip level and synchronizes with the IEEE 802.15.4-2003 preamble. An automatic gain control (AGC) module adjusts the analog IF gain continuously (every ¼ symbol) until the preamble is detected. Once the packet preamble is detected, the IF gain is fixed during the packet reception. The baseband de-spreads the demodulated data into 4-bit symbols. These symbols are buffered and passed to the hardware-based MAC module for filtering.

In addition, the RX baseband provides the calibration and control interface to the analog RX modules, including the LNA, RX Baseband Filter, and modulation modules. The EmberZNet software includes calibration algorithms which use this interface to reduce the effects of process and temperature variation.

6.1.2 RSSI and CCA

The SN260 calculates the RSSI over an 8-symbol period as well as at the end of a received packet. It utilizes the RX gain settings and the output level of the ADC within its algorithm. The linear range of RSSI is specified to be 40dB over all temperatures. At room temperature, the linear range is approximately 60dB (-90 dBm to -30dBm).

The SN260 RX baseband provides support for the IEEE 802.15.4-2003 required CCA methods summarized in *Table 3*. Modes 1, 2, and 3 are defined by the 802.15.4-2003 standard; Mode 0 is a proprietary mode.

Table 3. CCA mode behavior

CCA mode	Mode behavior
0	Clear channel reports busy medium if either carrier sense OR RSSI exceeds their thresholds.
1	Clear channel reports busy medium if RSSI exceeds its threshold.
2	Clear channel reports busy medium if carrier sense exceeds its threshold.
3	Clear channel reports busy medium if both RSSI and carrier sense exceed their thresholds.

The EmberZNet Software Stack sets the CCA Mode, and it is not configurable by the Application Layer. For software versions beginning with EmberZNet 2.5.4, CCA Mode 1 is used, and a busy channel is reported if the RSSI exceeds its threshold. For software versions prior to 2.5.4, the CCA Mode was set to 0.

At RX input powers higher than –25 dBm, there is some compression in the receive chain where the gain is not properly adjusted. In the worst case, this has resulted in packet loss of up to 0.1%. This packet loss can be seen in range testing measurements when nodes are closely positioned and transmitting at high power or when receiving from test equipment. There is no damage to the SN260 from this problem. This issue will rarely occur in the field as ZigBee Nodes will be spaced far enough apart. If nodes are close enough for it to occur in the field, the MAC and networking software treat the packet as not having been received and therefore the MAC level and network level retries resolve the problem without needing to notify the upper level application.

6.2 Transmit (TX) path

The SN260 transmitter utilizes both analog circuitry and digital logic to produce the O-QPSK modulated signal. The area-efficient TX architecture directly modulates the spread symbols prior to transmission. The differential signal paths increase noise immunity and provide a common interface for the external balun.

6.2.1 TX baseband

The SN260 TX baseband (within the digital domain) performs the spreading of the 4-bit symbol into its IEEE 802.15.4-2003-defined 32-chip I and Q sequence. In addition, it provides the interface for software to perform the calibration of the TX module in order to reduce process, temperature, and voltage variations.

6.2.2 TX_ACTIVE signal

Even though the SN260 provides an output power suitable for most ZigBee applications, some applications will require an external power amplifier (PA). Due to the timing requirements of IEEE 802.15.4-2003, the SN250 provides a signal, TX_ACTIVE, to be used for external PA power management and RF Switching logic. When in TX, the TX Baseband drives TX_ACTIVE high (as described in *Table 15*). When in RX, the TX_ACTIVE signal is low. If an external PA is not required, then the TX_ACTIVE signal should be connected to GND through a 100k Ohm resistor, as shown in the application circuit in *Figure 14*.

The TX_ACTIVE signal can only source 1mA of current, and it is based upon the 1.8V signal swing. If the PA Control logic requires greater current or voltage potential, then TX_ACTIVE should be buffered externally to the SN260.

6.3 Integrated MAC module

The SN260 integrates critical portions of the IEEE 802.15.4-2003 MAC requirements in hardware. This allows the SN260 to provide greater bandwidth to application and network operations. In addition, the hardware acts as a first-line filter for non-intended packets. The SN260 MAC utilizes a DMA interface to RAM memory to further reduce the overall microcontroller interaction when transmitting or receiving packets.

When a packet is ready for transmission, the software configures the TX MAC DMA by indicating the packet buffer RAM location. The MAC waits for the backoff period, then transitions the baseband to TX mode and performs channel assessment. When the channel is clear, the MAC reads data from the RAM buffer, calculates the CRC, and provides 4-bit symbols to the baseband. When the final byte has been read and sent to the baseband, the CRC remainder is read and transmitted.

The MAC resides in RX mode most of the time, and different format and address filters keep non-intended packets from using excessive RAM buffers, as well as preventing the SN260 CPU from being interrupted. When the reception of a packet begins, the MAC reads 4-bit symbols from the baseband and calculates the CRC. It assembles the received data for storage in a RAM buffer. A RX MAC DMA provides direct access to the RAM memory. Once the packet has been received, additional data is appended to the end of the packet in the RAM buffer space. The appended data provides statistical information on the packet for the software stack.

The primary features of the MAC are:

- CRC generation, appending, and checking
- Hardware timers and interrupts to achieve the MAC symbol timing
- Automatic preamble, and SFD pre-pended to a TX packet
- Address recognition and packet filtering on received packets
- Automatic acknowledgement transmission
- Automatic transmission of packets from memory
- Automatic transmission after backoff time if channel is clear (CCA)
- Automatic acknowledgement checking
- Time stamping of received and transmitted messages
- Attaching packet information to received packets (LQI, RSSI, gain, time stamp, and packet status)
- IEEE 802.15.4-2003 timing and slotted/unslotted timing

6.4 Packet trace interface (PTI)

The SN260 integrates a true PHY-level PTI for effective network-level debugging. This two-signal interface monitors all the PHY TX and RX packets (in a non-intrusive manner) between the MAC and baseband modules. It is an asynchronous 500 kbps interface and cannot be used to inject packets into the PHY/MAC interface. The two signals from the SN260 are the frame signal (PTI_EN) and the data signal (PTI_DATA). The PTI is supported by InSight Desktop.

SN260

6.5 16-bit microprocessor

The SN260 integrates the XAP2b microprocessor developed by Cambridge Consultants Ltd., making it a true network processor solution. The XAP2b is a 16-bit Harvard architecture processor with separate program and data address spaces. The word width is 16 bits for both the program and data sides.

The standard XAP2 microprocessor and accompanying software tools have been enhanced to create the XAP2b microprocessor used in the SN260. The XAP2b adds data-side byte addressing support to the XAP2 allowing for more productive usage of RAM and optimized code.

The XAP2b clock speed is 12MHz. When used with the EmberZNet stack, firmware may be loaded into Flash memory using the SIF mechanism (described in *Section 9: SIF module programming and debug interface*) or over the air or by a serial link using a built-in bootloader1 in a reserved area of the Flash. Alternatively, firmware may be loaded via the SIF interface with the assistance of RAM-based utility routines also loaded via SIF.

6.6 Embedded memory

The SN260 contains embedded Flash and RAM memory for firmware storage and execution. In addition it partitions a portion of the Flash for simulated EEPROM and token storage.

6.6.1 Simulated EEPROM

The protocol stack reserves a section of Flash memory to provide simulated EEPROM storage area for stack and customer tokens. The Flash cell has been qualified for a data retention time of >100 years at room temperature and is rated to have a guaranteed 1,000 write/erase cycles. Because the Flash cells are qualified for up to 1,000 write cycles, the simulated EEPROM implements an effective wear-leveling algorithm which effectively extends the number of write cycles for individual tokens.

The number of set-token operations is finite due to the write cycle limitation of the Flash. It is not possible to guarantee an exact number of set-token operations because the life of the simulated EEPROM depends on which tokens are written and how often.

The SN260 stores non-volatile information necessary for network operation as well as 8 tokens available to the Host. The majority of internal tokens are only written when the SN260 performs a network join or leave operation. As a simple estimate of possible settoken operations, consider an SN260 in a stable network (no joins or leaves) not sending any messages where the Host uses only one of the 8-byte tokens available to it. Under this scenario, a very rough estimate results in approximately 330,000 possible set-token operations. The number of possible set-token calls, though, depends on which tokens are being set, so the ratios of set-token calls for each token plays a large factor. A very rough estimate for the total number of times an App token can be set is approximately 320,000.

These estimates would typically increase if the SN260 is kept closer to room temperature, since the 1,000 guaranteed write cycles of the Flash is for across temperature.

6.6.2 Flash information area (FIA)

The SN260 also includes a separate 1024-byte FIA that can be used for storage of data during manufacturing, including serial numbers and calibration values. Programming of this special Flash page can only be enabled using the SIF interface to prevent accidental corruption or erasure. The EmberZNet stack reserves a small portion of this space for its own use and in addition makes eight manufacturing tokens available to the application.

6.7 Encryption accelerator

The SN260 contains a hardware AES encryption engine that is attached to the CPU using a memory-mapped interface. The CBC-MAC and CTR modes are implemented in hardware, and CCM* is implemented in software. The first two modes are described in the IEEE 802.15.4-2003 specification. CCM* is described in the ZigBee Specification (ZigBee Document 053474). The EmberZNet stack implements a security API for applications that require security at the application level.

6.8 nRESET signal

When the asynchronous external reset signal, nRESET (Pin 13), is driven low for a time greater than 200ns, the SN260 resets to its default state. An integrated glitch filter prevents noise from causing an inadvertent reset to occur. If the SN260 is to be placed in a noisy environment, an external LC Filter or supervisory reset circuit is recommended to guarantee the integrity of the reset signal.

When nRESET asserts, all SN260 registers return to their reset state. In addition, the SN260 consumes 1.5mA (typical) of current when held in RESET.

6.9 Reset detection

The SN260 contains multiple reset sources. The reset event is logged into the reset source register, which lets the CPU determine the cause of the last reset. The following reset causes are detected:

- Power-on-reset
- Watchdog
- PC rollover
- Software reset
- Core power dip

6.10 Power-on-reset (POR)

Each voltage domain (1.8V digital core supply VDD_CORE and pads supply VDD_PADS) has a power-on-reset (POR) cell.

The VDD_PADS POR cell holds the always-powered high-voltage domain in reset until the following conditions have been met:

- The high-voltage pads supply VDD_PADS voltage rises above a threshold.
- The internal RC clock starts and generates three clock pulses.
- The 1.8V POR cell holds the main digital core in reset until the regulator output voltage rises above a threshold.

Additionally, the digital domain counts 1,024 clock edges on the 24MHz crystal before releasing the reset to the main digital core.

Table 4 lists the features of the SN260 POR circuitry.

Table 4. POR specifications

Parameter	Min.	Тур.	Max.	Unit
VDD_PADS POR release	1.00	1.20	1.40	V
VDD_PADS POR assert	0.50	0.60	0.70	V
1.8V POR release	1.35	1.50	1.65	V
1.8V POR hysteresis	0.08	0.10	0.12	V

6.11 Clock sources

The SN260 integrates two oscillators: a high-frequency 24-MHz crystal oscillator and a low-frequency internal 10-kHz RC oscillator.

6.11.1 High-frequency crystal oscillator

The integrated high-frequency crystal oscillator requires an external 24MHz crystal with an accuracy of ± 40 ppm. Based upon the application bill of materials and current consumption requirements, the external crystal can cover a range of ESR requirements. For a lower ESR, the cost of the crystal increases but the overall current consumption decreases. Likewise, for higher ESR, the cost decreases but the current consumption increases. Therefore, the designer can choose a crystal to fit the needs of the application.

Table 5 lists the specifications for the high-frequency crystal.

Table 5. High-frequency crystal specifications

Parameter	Test conditions	Min.	Тур.	Max.	Unit
Frequency			24		MHz
Duty cycle		40		60	%
Phase noise from 1 kHz to 100 kHz				- 120	dBc/Hz
Accuracy	Initial, temperature, and aging	- 40		+ 40	ppm

5/

Parameter Test conditions Min. Typ. Max. Unit Crystal ESR Load capacitance of 10pF 100 Ω Crystal ESR Load capacitance of 18pF 60 Ω Start-up time to stable 1 ms clock (max. bias) Start-up time to stable 2 ms clock (optimum bias) Current consumption Good crystal: 20Ω ESR, 10pF load 0.2 0.3 mΑ Worst-case crystals (60Ω, 18pF or Current consumption 0.5 mΑ 100Ω , 10pF) Current consumption At maximum bias 1 mΑ

Table 5. High-frequency crystal specifications (continued)

6.11.2 Internal RC oscillator

The SN260 has a low-power, low-frequency RC oscillator that runs all the time. Its nominal frequency is 10 kHz.

The RC oscillator has a coarse analog trim control, which is first adjusted to get the frequency as close to 10 kHz as possible. This raw clock is used by the chip management block. It is also divided down to 1kHz using a variable divider to allow software to accurately calibrate it. This calibrated clock is used by the sleep timer.

Timekeeping accuracy depends on temperature fluctuations the chip is exposed to, power supply impedance, and the calibration interval, but in general it will be better than 150 ppm (including crystal error of 40 ppm).

Table 6 lists the specifications of the RC oscillator.

Table 6. RC oscillator specifications

Parameter	Test conditions	Min.	Тур.	Max.	Unit
Frequency			10		kHz
Analog trim steps			1		kHz
Frequency variation with supply	For a voltage drop from 3.6V to 3.1V or 2.6V to 2.1V		0.75	1.5	%

6.12 Random number generator

The SN260 allows for the generation of random numbers by exposing a randomly generated bit from the RX ADC. Analog noise current is passed through the RX path, sampled by the receive ADC, and stored in a register. The value contained in this register could be used to seed a software-generated random number. The EmberZNet stack utilizes these random numbers to seed the random MAC backoff and encryption key generators.

6.13 Watchdog timer

The SN260 contains an internal watchdog timer clocked from the internal oscillator. If the timer reaches its time-out value of approximately 2 seconds, it will reset the SN260. This reset signal cannot be routed externally to the Host.

The SN260 firmware will periodically restart the watchdog timer while the firmware is running normally. The Host cannot effect or configure the watchdog timer.

6.14 Sleep timer

The 16-bit sleep timer is contained in the always-powered digital block. The clock source for the sleep timer is a calibrated 1kHz clock. The frequency is slowed down with a 2^N prescaler to generate a final timer resolution of 1ms. With a 1ms tick and a 16-bit timer, the timer wraps about every 65.5 seconds. The EmberZNet stack appropriately handles timer wraps allowing the Host to order a theoretical maximum sleep delay of 4 million seconds.

6.15 Power management

The SN260 supports four different power modes: active, idle, deep sleep, and power down.

Active mode is the normal, operating state of the SN260.

While in idle mode, code execution halts until any interrupt occurs. All modules of the SN260 including the radio continue to operate normally. The EmberZNet stack automatically invokes idle as appropriate.

Deep sleep mode and power down mode both power off most of the SN260, including the radio, and leave only the critical chip functions powered. The internal regulator is disabled and VREG_OUT is turned off. All output signals are maintained in a frozen state. Upon waking from deep sleep or power down mode, the internal regulator is re-enabled. Deep sleep and power down result in the same sleep current consumption. The two sleep modes differ as follows: the SN260 can wake on both an internal timer and an external signal from deep sleep mode; power down mode can only wake on an external signal.

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7 SPI protocol

The SN260 low level protocol centers on the SPI interface for communication with a pair of GPIO for handshake signaling.

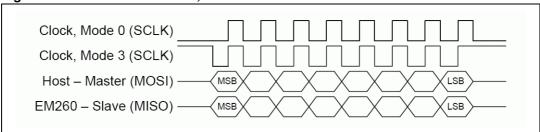
- The SN260 looks like a hardware peripheral.
- The SN260 is the slave device and all transactions are initiated by the Host (the master).
- The SN260 supports a reasonably high data rate.

7.1 Physical interface configuration

The SN260 supports both SPI Slave Mode 0 (clock is idle low, sample on rising edge) and SPI Slave Mode 3 (clock is idle high, sample on rising edge) at a maximum SPI clock rate of 5MHz, as illustrated in *Figure 4*.

Note: The convention for the waveforms in this document is to show Mode 0.

Figure 4. SPI transfer format, Mode 0 and Mode 3

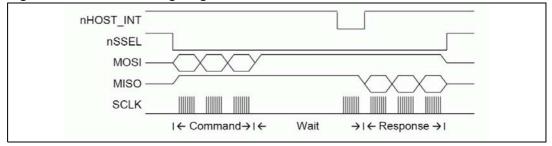


The nHOST_INT signal and the nWAKE signal are both active low. The Host must supply a pull-up resistor on the nHOST_INT signal to prevent errant interruptions during undefined events such as the SN260 resetting. The SN260 supplies an internal pull-up on the nWAKE signal to prevent errant interruptions during undefined events such as the Host resetting.

7.2 SPI transaction

The basic SN260 SPI transaction is half-duplex to ensure proper framing and to give the SN260 adequate response time. The basic transaction, as shown in *Figure 5*, is composed of three sections: Command, Wait, and Response. The transaction can be considered analogous to a function call. The Command section is the function call, and the Response section is the return value.

Figure 5. General timing diagram for a SPI transaction



SN260 SPI protocol

7.2.1 Command section

The Host begins the transaction by asserting the Slave Select and then sending a command to the SN260. This command can be of any length from 2 to 136 bytes and must not begin with $0 \times FF$. During the Command section, the SN260 will respond with only $0 \times FF$. The Host should ignore data on MISO during the Command section. Once the Host has completed transmission of the entire message, the transaction moves to the Wait section.

7.2.2 Wait section

The Wait section is a period of time during which the SN260 may be processing the command or performing other operations. Note that this section can be any length of time up to 200 milliseconds. Because of the variable size of the Wait section, an interrupt-driven or polling-driven method is suggested for clocking the SPI as opposed to a DMA method. Since the SN260 can require up to 200 milliseconds to respond, as long as the Host keeps Slave Select active, the Host can perform other tasks while waiting for a Response.

To determine when a Response is ready, use one of two methods:

- Clock the SPI until the SN260 transmits a byte other than 0xFF.
- Interrupt on the falling edge of nHOST_INT.

The first method, clocking the SPI, is recommended due to simplicity in implementing. During the Wait section, the SN260 will transmit only $0 \times FF$ and will ignore all incoming data until the Response is ready. When the SN260 transmits a byte other than $0 \times FF$, the transaction has officially moved into the Response section. Therefore, the Host can poll for a Response by continuing to clock the SPI by transmitting $0 \times FF$ and waiting for the SN260 to transmit a byte other than $0 \times FF$. The SN260 will also indicate that a Response is ready by asserting the nHOST_INT signal. The falling edge of nHOST_INT is the indication that a Response is ready. Once the nHOST_INT signal asserts, nHOST_INT will return to idle after the Host begins to clock data.

7.2.3 Response section

When the SN260 transmits a byte other than 0xFF, the transaction has officially moved into the Response section. The data format is the same format used in the Command section. The response can be of any length from 2 to 136 bytes and will not begin with 0xFF. Depending on the actual response, the length of the response is known from the first or second byte and this length should be used by the Host to clock out exactly the correct number of bytes. Once all bytes have been clocked, it is allowable for the Host to de-assert chip select. Since the Host is in control of clocking the SPI, there are no ACKs or similar signals needed back from the Host because the SN260 will assume the Host could accept the bytes being clocked on the SPI. After every transaction, the Host must hold the Slave Select high for a minimum of 1ms. This timing requirement is called the inter-command spacing and is necessary to allow the SN260 to process a command and become ready to accept a new command.

7.2.4 Asynchronous signaling

When the SN260 has data to send to the Host, it will assert the nHOST_INT signal. The nHOST_INT signal is designed to be an edge-triggered signal as opposed to a level-triggered signal; therefore, the falling edge of nHOST_INT is the true indicator of data availability. The Host then has the responsibility to initiate a transaction to ask the SN260 for its output. The Host should initiate this transaction as soon as possible to prevent possible

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backup of data in the SN260. The SN260 will de-assert the nHOST_INT signal after receiving a byte on the SPI. Due to inherent latency in the SN260, the timing of when the nHOST_INT signal returns to idle can vary between transactions. nHOST_INT will always return to idle for a minimum of 10µs before asserting again. If the SN260 has more output available after the transaction has completed, the nHOST_INT signal will assert again after Slave Select is de-asserted and the Host must make another request.

7.2.5 Spacing

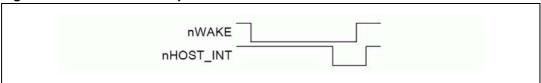
To ensure that the SN260 is always able to deal with incoming commands, a minimum intercommand spacing is defined at 1ms. After every transaction, the Host must hold the Slave Select high for a minimum of 1ms. The Host must respect the inter-command spacing requirement, or the SN260 will not have time to operate on the command; additional commands could result in error conditions or undesired behavior. If the nHOST_INT signal is not already asserted, the Host is allowed to use the Wake handshake instead of the intercommand spacing to determine if the SN260 is ready to accept a command.

7.2.6 Waking the SN260 from sleep

Waking up the SN260 involves a simple handshaking routine as illustrated in *Figure 6*. This handshaking ensures that the Host will wait until the SN260 is fully awake and ready to accept commands from the Host. If the SN260 is already awake when the handshake is performed (such as when the Host resets and the SN260 is already operating), the handshake will proceed as described below with no ill effects.

Note: A wake handshake cannot be performed if nHOST_INT is already asserted.

Figure 6. SN260 wake sequence



Waking the SN260 involves the following steps:

- Host asserts nWAKE.
- 2. SN260 interrupts on nWAKE and exits sleep.
- 3. SN260 performs all operations it needs to and will not respond until it is ready to accept commands.
- SN260 asserts nHOST_INT within 10ms of nWAKE asserting. If the SN260 does not assert nHOST_INT within 10ms of nWAKE, it is valid for the Host to consider the SN260 unresponsive and to reset the SN260.
- 5. Host detects nHOST_INT assertion. Since the assertion of nHOST_INT indicates the SN260 can accept SPI transactions, the Host does not need to hold Slave Select high for the normally required minimum 1ms of inter-command spacing.
- 6. Host de-asserts nWAKE after detecting nHOST_INT assertion.
- 7. SN260 will de-assert nHOST_INT within 25 μs of nWAKE de-asserting.
- 8. After 25µs, any change on nHOST_INT will be an indication of a normal asynchronous (callback) event.

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7.2.7 Error conditions

If two or more different error conditions occur back to back, only the first error condition will be reported to the Host (if it is possible to report the error). The following are error conditions that might occur with the SN260.

Unsupported SPI command

If the SPI Byte of the command is unsupported, the SN260 will drop the incoming command and respond with the Unsupported SPI Command Error Response. This error means the SPI Byte is unsupported by the current Mode the SN260 is in. Bootloader Frames can only be used with the bootloader and EZSP Frames can only be used with the EZSP.

Oversized Payload frame

If the transaction includes a Payload Frame, the Length Byte cannot be a value greater than 133. If the SN260 detects a length byte greater than 133, it will drop the incoming Command and abort the entire transaction. The SN260 will then assert nHOST_INT after Slave Select returns to Idle to inform the Host through an error code in the Response section what has happened. Not only is the Command in the problematic transaction dropped by the SN260, but the next Command is also dropped, because it is responded to with the Oversized Payload Frame Error Response.

Aborted transaction

An aborted transaction is any transaction where Slave Select returns to Idle prematurely and the SPI Protocol dropped the transaction. The most common reason for Slave Select returning to Idle prematurely is the Host unexpectedly resetting. If a transaction is aborted, the SN260 will assert nHOST_INT to inform the Host through an error code in the Response section what has happened. When a transaction is aborted, not only does the Command in the problematic transaction get dropped by the SN260, but the next Command also gets dropped since it is responded to with the Aborted Transaction Error Response.

Missing frame terminator

Every Command and Response must be terminated with the Frame Terminator byte. The SN260 will drop any Command that is missing the Frame Terminator. The SN260 will then immediately provide the Missing Frame Terminator Error Response.

Long transaction

A Long Transaction error occurs when the Host clocks too many bytes. As long as the inter-command spacing requirement is met, this error condition should not cause a problem, since the SN260 will send only $0 \times FF$ outside of the Response section as well as ignore incoming bytes outside of the Command section.

Unresponsive

Unresponsive can mean the SN260 is not powered, not fully booted yet, incorrectly connected to the Host, or busy performing other tasks. The Host must wait the maximum length of the Wait section before it can consider the SN260 unresponsive to the Command section. This maximum length is 200 milliseconds, measured from the end of the last byte sent in the Command Section. If the SN260 ever fails to respond during the Wait section, it is valid for the Host to consider the SN260 unresponsive and to reset the SN260. Additionally, if nHOST_INT does not assert within 10ms of nWAKE asserting during the wake handshake, the Host can consider the SN260 unresponsive and reset the SN260.